

Vishay Siliconix

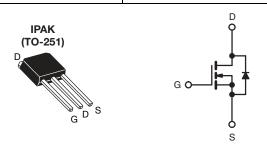
**RoHS** 

HALOGEN

FREE

## **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	10	100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.54				
Q <sub>g</sub> (Max.) (nC)	8.3	3				
Q <sub>gs</sub> (nC)	2.3	3				
Q <sub>gd</sub> (nC)	3.8	3				
Configuration	Sing	gle				



N-Channel MOSFET

#### **FEATURES**

 Halogen-free According to IEC 61249-2-21 Definition



- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

ORDERING INFORMATION				
Package	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFU110-GE3			
Lead (Pb)-free	IRFU110PbF			
Lead (i b) iide	SiHFU110-E3			
SnPb	IRFU110			
Oil D	SiHFU110			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	100	V	
Gate-Source Voltage			$V_{GS}$	± 20	7 v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		4.3	А	
Continuous Drain Current		T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.7		
Pulsed Drain Current <sup>a</sup>	rain Current <sup>a</sup>			17		
inear Derating Factor				0.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	75	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	4.3	Α	
Repetitive Avalanche Energya			E <sub>AR</sub>	2.5	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		P <sub>D</sub>	25	W	
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	00	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 8.1 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 4.3 A (see fig. 12).
- c.  $I_{SD} \le 5.6$  A,  $dI/dt \le 75$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFU110, SiHFU110

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	-	110	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	=	5.0	C/VV	

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	SYMBOL	1	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
	STIVIDOL	IES	T CONDITIONS	IVIIIN.	ITP.	WAA.	ONIT
Static		T	= 0 V, I <sub>D</sub> = 250 μA	400			
Drain-Source Breakdown Voltage	V <sub>DS</sub>		100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	+	e to 25 °C, I <sub>D</sub> = 1 mA	2.0	0.63	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>		$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	μA
2010 date voltage Dialii Guileit	יטסט	$V_{DS} = 80 \text{ V}$	=	-	250	μ, τ	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 0.90 A^b$	-	-	0.54	Ω
Forward Transconductance	9fs	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 0.90 A		1.1	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	180	-	pF
Output Capacitance	C <sub>oss</sub>			-	81	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	15	-	
Total Gate Charge	Qg		I <sub>D</sub> = 5.6 A, V <sub>DS</sub> = 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	8.3	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	2.3	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	3.8	
Turn-On Delay Time	t <sub>d(on)</sub>			-	6.9	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $I_D$ = 5.6 A, $R_g$ = 24 $\Omega$ , $R_D$ = 8.4 $\Omega$ , see fig. 10 <sup>b</sup>		-	16	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	9.4	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	- nH
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	
Drain-Source Body Diode Characteristic	s			,		•	
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.5	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	12	
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C}, \ I_S = 1.5  \text{A}, \ V_{GS} = 0  \text{V}^{\text{b}}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 5.6 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	100	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.44	0.88	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L				<u>L</u> D)	

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

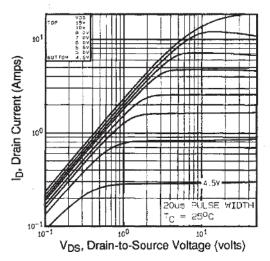


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

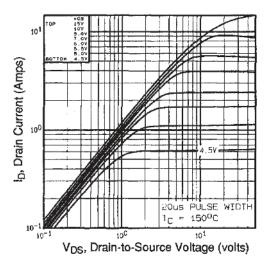


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

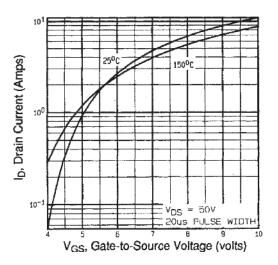


Fig. 3 - Typical Transfer Characteristics

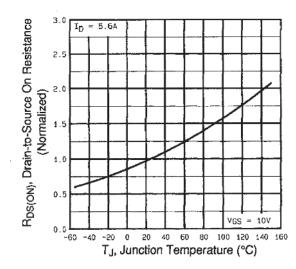


Fig. 4 - Normalized On-Resistance vs. Temperature

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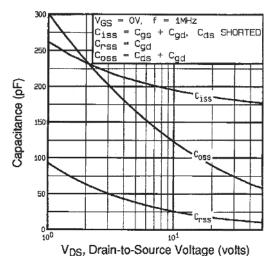


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

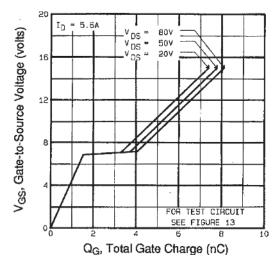


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

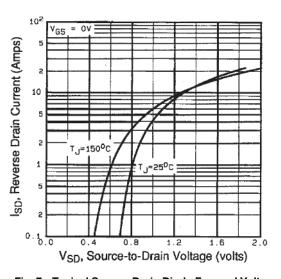


Fig. 7 - Typical Source-Drain Diode Forward Voltage

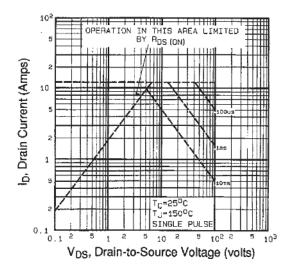


Fig. 8 - Maximum Safe Operating Area





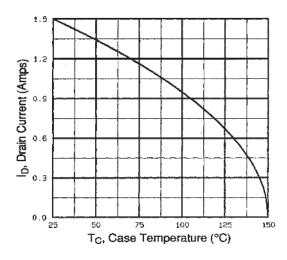


Fig. 9 - Maximum Drain Current vs. Case Temperature

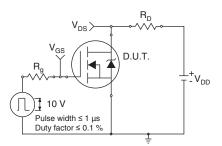


Fig. 10a - Switching Time Test Circuit

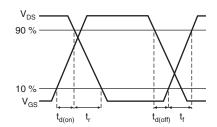


Fig. 10b - Switching Time Waveforms

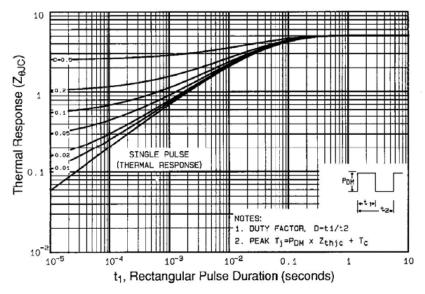


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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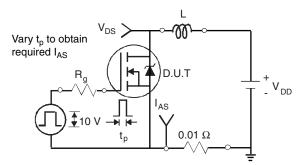


Fig. 12a - Unclamped Inductive Test Circuit

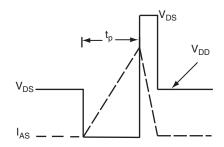


Fig. 12b - Unclamped Inductive Waveforms

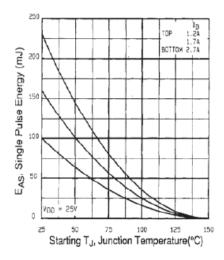


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

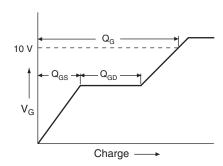


Fig. 13a - Basic Gate Charge Waveform

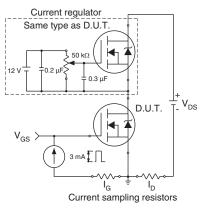
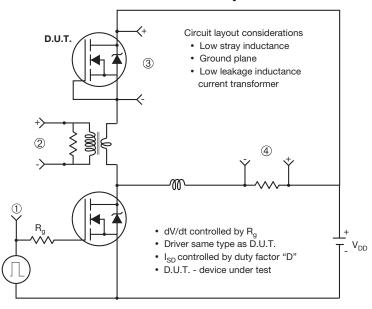


Fig. 13b - Gate Charge Test Circuit





#### Peak Diode Recovery dV/dt Test Circuit



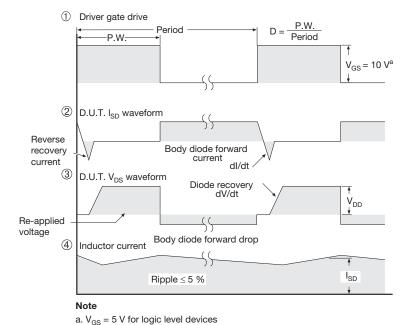


Fig.14 - For N-Channel

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